

Electronic Patent Application Fee Transmittal

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|---|------------------------------------|-----------------|---------------|-----------------------------|
| Application Number: | 10561821 | | | |
| Filing Date: | | | | |
| Title of Invention: | Processing method of silicon wafer | | | |
| First Named Inventor/Applicant Name: | Sakae Koyata | | | |
| Filer: | Jules Edward Goldberg/Julia Watts | | | |
| Attorney Docket Number: | JG-SU-521/500577.20071 | | | |
| Filed as Large Entity | | | | |
| U.S. National Stage under 35 USC 371 Filing Fees | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Late filing fee for oath or declaration | 1051 | 1 | 130 | 130 |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-------------------|----------|----------|--------|----------------------|
| Miscellaneous: | | | | |
| Total in USD (\$) | | | | 130 |